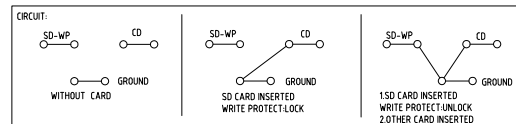


Pin No.		SD	MMSC
P1	MMC-DAT SD-DAT3	1P	7P
P2	MMC-CMD SD-CMD	2P	2P
P3	MMC-VSS1 SD-VSS1 接地	3P	3P
P4	MMC-VDD SD-VDD	4P	4P
P5	MMC-CLK SD-CLK	5P	5P
P6	MMC-VSS2 SD-VSS2 接地	6P	6P
P7	MMC-DAT SD-DAT0	7P	1P
P8	SD-DAT1	8P	
P9	SD-DAT2	9P	

PCB LAYOUT



**SPECIFICATION**

**Electrical :**

- 1.Current Rating: 0.5mA AC / DC Max
- 2.Voltage Rating: 125V AC / DC
- 3.Contact Resistance: 100 mΩ Max.
- 4.Insulation Resistance: 1,000 MΩ Min.

**Environmental:**

- 1.Operating Temperature: -20°C ~ +90°C.

**Material:**

- 1.Housing: LCP,Black
- 2.Contact: Phosphor Bronze
- 3.Shell: SUS

**Finish:**

- 1.Contact: Plated Gold in Mating Area ;  
Tin Plated on Solder Balls ;  
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer

ITEM NO.	DESCRIPTION	DRAWN	DATE
2	更新圖面	Jack	062419
1	更新圖面	Jack	081018

**CONTACT 建倚科技股份有限公司**  
**CONTACT TECHNOLOGY CORP.**

TOLERANCE UNLESS OTHERWISE STATED :  
Up to 5 ±0.2  
Above 5 ~ 15 ±0.3  
Above 15 ~ 30 ±0.4  
Above 30 ~ 50 ±0.5  
Angle ±0.3

3RD. ANGEL'S  
UNITS MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	06/24/19			
CHECKED BY:	DATE	FINISH	MODLE	CARD CONNECTOR
Jacky Chen	06/24/19			
APPROVED BY:	DATE	SCALE	DWG NO.	SD-001-001-S267
Tony Kao	06/24/19	1 : 1	PART NO.	SD-001-001-S267
		SHEET NO.	1 of 1	
				SIZE A4
				VER R2